

Issue	Market Index	VIP Interview	Cover Story	Trend Insights	Components & Modules	Distribution & Supply Chain	Manufacturing and Process	Specials
<b>January</b> Ad Booking Deadline: 20-Nov-2023 Ad Materials Deadline: 24-Nov-2023	•	•	Trends and Prospects of semiconductor application in 2024	Consumer electronics market status	Communication module	Distribution market pattern	-	
<b>February</b> Ad Booking Deadline: 20-Dec-2023 Ad Materials Deadline: 25-Dec-2023	•	•	Supply chain overseas opportunities	Wind power, Photovoltaic, Energy Storage Applications	Storage controller	Compliance and Certification	Wafer manufacturing	
<b>March</b> Ad Booking Deadline: 18-Jan-2024 Ad Materials Deadline: 20-Jan-2024	•	•	Big data and cloud computing	New Wave of Semiconductor Chips	Image Sensor	Distribution Trends	-	
<b>April</b> Ad Booking Deadline: 20-Feb-2024 Ad Materials Deadline: 26-Feb-2024	•	•	Smart City	Smart Healthcare	Micro motor	E-commerce distribution	New manufacturing materials	
<b>May</b> Ad Booking Deadline: 20-Mar-2024 Ad Materials Deadline: 25-Mar-2024	•	•	Local IC market analysis	Crystal oscillators	Wireless charging	Intelligent warehousing and logistics		
<b>June</b> Ad Booking Deadline: 19-Apr-2024 Ad Materials Deadline: 25-Apr-2024	•	•	Ranking of Global/China distributors in 2023	Memory/storage Market	Power electronic devices	Test & Measurement	PCB manufacturing	
<b>July</b> Ad Booking Deadline: 20-May-2024 Ad Materials Deadline: 24-May-2024	•	•	Intelligent manufacturing	Automotive Electronics Market	Wireless module	Digital management		
<b>August</b> Ad Booking Deadline: 20-Jun-2024 Ad Materials Deadline: 25-Jun-2024	•	•	Semiconductor investment and financing	Smart Wearables	Crystal oscillators	supply chain security	Semiconductor equipment	AIoT Special Report
<b>September</b> Ad Booking Deadline: 19-Jul-2024 Ad Materials Deadline: 25-Jul-2024	•	•	Third generation semiconductor	Robot	MEMS sensor	Distribution model		
<b>October</b> Ad Booking Deadline: 20-Aug-2024 Ad Materials Deadline: 26-Aug-2024	•	•	Green energy storage	Laser/Millimeter Wave/Ultrasonic Radar	RF front-end	Distribution and Capital	Automated testing	
<b>November</b> Ad Booking Deadline: 20-Sep-2024 Ad Materials Deadline: 25-Sep-2024	•	•	New energy vehicle applications	Smart home appliances	Power modules	Post-distribution services market opportunities		
<b>December</b> Ad Booking Deadline: 21-Oct-2024 Ad Materials Deadline: 25-Oct-2024	•	•	AI/ML	Machine Vision	•Capacitors •Resistors •Inductors	Supply Chain Service	Semiconductor packaging	Distributors and Supply Chain Special Report

#### Editorial Inquiries

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**Note:** The publisher retains the right to reschedule any topic in the calendar.